

SLOVENSKI STANDARD SIST EN 300 253 V2.2.1:2015

01-oktober-2015

Okoljski inženiring (EE) - Konfiguracija ozemljitev in povezav opreme IKT z enosmernim napajanjem - 48 V v telekomunikacijskih in podatkovnih centrih

Environmental Engineering (EE); Earthing and bonding of ICT equipment powered by -48 VDC in telecom and data centres

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a3975754dbc3/sist-en-300-253-v2-2-1-2015

ICS:

19.040 Preskušanje v zvezi z

okoljem

33.050.01 Telekomunikacijska

terminalska oprema na

splošno

Environmental testing

Telecommunication terminal

equipment in general

SIST EN 300 253 V2.2.1:2015

en,fr,de

SIST EN 300 253 V2.2.1:2015

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SIST EN 300 253 V2.2.1;2015 https://standards.iteh.ai/catalog/standards/sist/07f2d062-a6c1-46c4-9c4a-a3975754dbc3/sist-en-300-253-v2-2-1-2015 SIST EN 300 253 V2.2.1:2015

ETSI EN 300 253 V2.2.1 (2015-06)



Environmental Engineering (EE); Earthing and bonding of ICT equipment powered by -48 VDC in telecom and data centres

SIST EN 300 253 V2.2.1:2015 https://standards.iteh.ai/catalog/standards/sist/07f2d062-a6c1-46c4-9c4a-a3975754dbc3/sist-en-300-253-v2-2-1-2015 Reference

REN/EE-0250

Keywords

bonding, earthing, equipment practice

ETSI

650 Route des Lucioles F-06921 Sophia Antipolis Cedex - FRANCE

Tel.: +33 4 92 94 42 00 Fax: +33 4 93 65 47 16

Siret N° 348 623 562 00017 - NAF 742 C Association à but non lucratif enregistrée à la Sous-Préfecture de Grasse (06) N° 7803/88

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SIST EN 300 253 V2.2.1:2015

https://standards.iteh.ai/catalog/standards/sist/07f2d062-a6c1-46c4-9c4a-

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Foreword

This European Standard (EN) has been produced by ETSI Technical Committee Environmental Engineering (EE).

The present document has been produced within the framework of the following considerations:

- a) ICT equipment is generally installed in telecommunication or data centres and held in racks, cabinets or other mechanical structures;
- b) the existing Recommendation ITU-Ts and CENELEC standards in such matters do not ensure the required standardization at the equipment level;
- c) network operators and equipment providers agreed to standardize on a bonding configuration that facilitates:
 - compliance with functional requirements including Electromagnetic Compatibility (EMC) aspects of emission and immunity;
 - compatible building and equipment provisions;
 - installation of new telecommunication or data centres as well as expansion or replacement of installations in existing telecommunication or data centres with equipment coming from different suppliers; a3975754dbc3/sist-en-300-253-v2-2-1-2015
 - a structured installation practice;
 - simple maintenance rules;
 - contracting on a common basis;
 - cost effectiveness in development, manufacturing, installation and operation.

National transposition dates		
Date of adoption of this EN:	26 May 2015	
Date of latest announcement of this EN (doa):	31 August 2015	
Date of latest publication of new National Standard or endorsement of this EN (dop/e):	29 February 2016	
Date of withdrawal of any conflicting National Standard (dow):	29 February 2016	

Modal verbs terminology

In the present document "shall", "shall not", "should", "should not", "may", "need not", "will", "will not", "can" and "cannot" are to be interpreted as described in clause 3.2 of the <u>ETSI Drafting Rules</u> (Verbal forms for the expression of provisions).

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Introduction

The present document addresses earthing and bonding of ICT equipment in telecommunication or data centres in relation to safety, functional performance and EMC.

Information regarding the general principles on earthing for telecommunication or data centres has been published by the ITU-T in the handbook on "Earthing of telecommunication installations" [i.1]. Recommendation ITU-T K.27 [i.2] deals with bonding configurations and earthing inside a telecommunication building or data centre. One bonding configuration only is selected from Recommendation ITU-T K.27 [i.2] (CBN/MESH-BN) and tailored to the present document.

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1 Scope

The present document applies to earthing and bonding of ICT equipment operating with DC voltage defined in ETSI EN 300 132-2 [i.9], in order to facilitate the installation, operation and maintenance of equipment.

It also co-ordinates with the pre-conditions of the installation to achieve the following targets:

- safety from electrical hazards;
- reliable signal reference;
- satisfactory Electromagnetic Compatibility (EMC) performance.

The specification of ICT equipment and of the pre-conditions of installation are subject to agreement of the parties (e.g. the supplier and the purchaser) and the procedure to achieve agreement is covered by annex A of the present document.

The present document does not cover safety and EMC aspects of the equipment. Those aspects are covered by other relevant standards.

The present document does not apply to the installation of ICT equipment in locations other than telecommunication and data centres, e.g. ICT equipment within a customer's building, including subscriber line termination.

NOTE: Earthing and bonding of equipment installed in locations other than telecommunication and data centres is covered by CENELEC EN 50310 [i.6].

2 References

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Normative references (standards.iteh.ai) 2.1

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NOTE: While any hyperlinks included in this clause were valid at the time of publication, ETSI cannot guarantee their long term validity.

The following referenced documents are necessary for the application of the present document.

- CENELEC HD 60364-4-41: "Low-voltage electrical installations Part 4-41: Protection for safety [1] - Protection against electric shock".
- [2] CENELEC HD 60364-5-54: "Low-voltage electrical installations - Part 5-54: Selection and erection of electrical equipment - Earthing arrangements, protective conductors and protective bonding conductors".
- [3] CENELEC EN 60950-1: "Information technology equipment - Safety - Part 1: General requirements".
- CENELEC EN 41003: "Particular safety requirements for equipment to be connected to [4] telecommunication networks and/or a cable distribution system".

2.2 Informative references

References are either specific (identified by date of publication and/or edition number or version number) or non-specific. For specific references, only the cited version applies. For non-specific references, the latest version of the reference document (including any amendments) applies.

While any hyperlinks included in this clause were valid at the time of publication, ETSI cannot guarantee NOTE: their long term validity.

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The following referenced documents are not necessary for the application of the present document but they assist the user with regard to a particular subject area.

[i.1]	ITU-T handbook: "Earthing of telecommunication installations".
[i.2]	Recommendation ITU-T K.27 (1991): "Bonding Configurations and Earthing inside a Telecommunication Building".
[i.3]	IEC 60050: "International Electrotechnical Vocabulary".
[i.4]	IEC 60050-604: "International Electrotechnical Vocabulary. Chapter 604: Generation, transmission and distribution of electricity - Operation".
[i.5]	IEC 60050-826: "International Electrotechnical Vocabulary. Electrical installations of buildings".
[i.6]	CENELEC EN 50310: "Application of equipotential bonding and earthing in buildings with information technology equipment".
[i.7]	CENELEC EN 62305 series: "Protection against lightning".
[i.8]	IEC 60050-195: "International Electrotechnical Vocabulary. Electrical installations of buildings". Earthing and protection against electric shock.
[i.9]	ETSI EN 300 132-2: "Environmental Engineering (EE); Power supply interface at the input to telecommunications and datacom (ICT) equipment; Part 2: Operated by -48 V direct current (dc)".
[i.10]	CENELEC EN 50162: "Protection against corrosion by stray current from d.c. system".
[i.11]	CENELEC HD 60364-1: "Electrical installation of buildings; Part 1: Scope, object and definitions". en

3 Definitions and abbreviations

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3.1 **Definition S**standards.iteh.ai/catalog/standards/sist/07f2d062-a6c1-46c4-9c4a-a3975754dbc3/sist-en-300-253-v2-2-1-2015

For the purposes of the present document, the following terms and definitions apply.

The following definitions with respect to earthing and bonding are introduced by the IEC 60050 [i.3] and are used within the present document to maintain conformity.

3.1.1 IEC definitions (by IEC 60050 numbers)

NOTE: IEC 60050 [i.3] references are given in parentheses (see IEC 60050-604 [i.4], IEC 60050-826 [i.5] and IEC 60050-195 [i.8]).

earth (195-01-03): part of the Earth which is in electric contact with an earth electrode and the electric potential of which is not necessarily equal to zero earthing arrangement

earthing conductor (195-02-03): conductor which provides a conductive path, or part of the conductive path, between a given point in a system or in an installation or in equipment and an earth electrode

earth electrode (195-02-01): conductive part, which may be embedded in a specific conductive medium, e.g. concrete or coke, in electric contact with the Earth

earthing network (604-04-07): part of an earthing installation that is restricted to the earth electrodes and their interconnections

equipotential bonding (195-01-10): provision of electric connections between conductive parts, intended to achieve equipotentiality

main earthing terminal (826-13-15): terminal or busbar which is part of the earthing arrangement of an installation and enabling the electric connection of a number of conductors for earthing purposes

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Neutral conductor (N) (826-01-03): conductor connected to the neutral point of a system and capable of contributing to the transmission of electrical energy

PEN conductor (826-13-25): conductor combining the functions of both a protective earthing conductor and a neutral conductor

protective earthing conductor (PE) (826-13-23): protective conductor provided for protective earthing

IT, TN-C, TN-S, and TT systems (see HD 60 364-1: The codes used have the following meanings:

First letter – Relationship of the power system to earth:

T = direct connection of one point to earth;

I = all live parts isolated from earth, or one point connected to earth through a high impedance.

Second letter – Relationship of the exposed-conductive-parts of the installation to earth:

T = direct electrical connection of exposed-conductive-parts to earth, independently of the earthing of any point of the power system;

N = direct electrical connection of the exposed-conductive-parts to the earthed point of the power system Subsequent letter(s) (if any) – Arrangement of neutral and protective conductors:

S = protective function provided by a conductor separate from the neutral conductor or from the earthed line conductor.

C = neutral and protective functions combined in a single conductor (PEN conductor).

3.1.2 Telecommunication definitions

The following definitions, specific to telecommunication or data centre installations and not covered by the IEC 60050 [i.3], are used within the present document. Correspondence to Recommendation ITU-T K.27 [i.2] is indicated as appropriate.

bonding mat: essential means to provide a SRPP by a discernible, nearly regular mesh structure

NOTE: The bonding mat may be located either below or above a collection of equipment constituting a system block.

(standards.iteh.ai)

Bonding Network (BN), (Recommendation ITU-T K.27 [i.2]): set of interconnected conductive structures that provides an "electromagnetic shield" for electronic systems and personnel at frequencies from Direct Current (DC) to low Radio Frequency (RF)_{https://standards.iteh.ai/catalog/standards/sist/07f2d062-a6c1-46c4-9c4a-}

NOTE: The term "electromagnetic shield" denotes any structure used to divert, block or impede the passage of electromagnetic energy. In general, a BN need not be connected to earth but all BNs considered in the present document will have an earth connection.

Common Bonding Network (CBN), (Recommendation ITU-T K.27 [i.2]): principal means for effective bonding and earthing inside a telecommunication building or data centre

NOTE: It is the set of metallic components that are intentionally or incidentally interconnected to form the principal BN in a building. These components include: structural steel or reinforcing rods, metallic plumbing, Alternating Current (AC) power conduit, PE conductors, cable racks and bonding conductors. The CBN always has a mesh topology and is connected to the earthing network.

DC return conductor: (+) conductor of the -48 V or -60 V secondary DC supply

ICT equipment: equipment designed for Information and Communication Technologies

NOTE: It is similar to Information Technology (IT), but focuses primarily on communication technologies. This includes the Internet, wireless networks, cell phones, and other communication mediums.

MESHed Bonding Network (MESH-BN), (Recommendation ITU-T K.27 [i.2]): bonding network in which all associated equipment frames, racks and cabinets and usually the DC power return conductor, are bonded together as well as at multiple points to the CBN

NOTE 1: Consequently, the MESH-BN augments the CBN.

NOTE 2: See figure 1 of the present document.

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MESHed Isolated Bonding Network (MESH-IBN), (Recommendation ITU-T K.27 [i.2]): type of IBN in which the components of the IBN (e.g. equipment frames) are interconnected to form a mesh-like structure

NOTE: This may, for example, be achieved by multiple interconnections between cabinet rows, or by connecting all equipment frames to a metallic grid (a "bonding mat") extending beneath the equipment. The bonding mat is, of course, insulated from the adjacent CBN. If necessary the bonding mat could include vertical extensions, resulting in an approximation to a Faraday cage. The spacing of the grid is chosen according to the frequency range of the electromagnetic environment.

power supply:

- primary supply: public mains or, under emergency conditions, a locally generated AC supply
- secondary supply: supply to the ICT equipment, racks or system block, derived from the primary supply
- **tertiary supplies:** supplies to the ICT equipment, derived from the secondary supply

system: regularly interacting or interdependent group of items forming a unified whole

system block: functional group of equipment depending in its operation and performance on its connection to the same system reference potential plane, inherent to a MESH-BN

System Reference Potential Plane (SRPP): conductive solid plane, as an ideal goal in potential equalizing, is approached in practice by horizontal or vertical meshes

NOTE 1: The mesh width thereof is adapted to the frequency range to be considered. Horizontal and vertical meshes may be interconnected to form a grid structure approximating to a Faraday cage.

NOTE 2: The SRPP facilitates signalling with reference to a common potential.

3.2 Abbreviations (standards.iteh.ai)

For the purposes of the present document, the following abbreviations apply:

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AC Alternatings Gurrents, itch.ai/catalog/standards/sist/07f2d062-a6c1-46c4-9c4a-

BN Bonding Network_{13975754dbc3/sist-en-300-253-v2-2-1-2015}

CBN Common Bonding Network

DC Direct Current

EMC ElectroMagnetic Compatibility
LPS Lightning Protection System
MESH-BN MESHed Bonding Network

MESH-IBN MESHed Isolated Bonding Network

N Neutral conductor

PE Protective Earth conductor

PEN combined Protective Earth and Neutral conductor

RF Radio Frequency

SRPP System Reference Potential Plane

4 General requirements

4.1 Safety from electrical hazards

To achieve safety the standards EN 60950-1 [3], EN 41003 [4] and CENELEC HD 60364-4-41 [1] shall be applied in the design of the equipment. The installation of PEs and equipotential bonding conductors shall be carried out in accordance with CENELEC HD 60364-5-54 [2].

The conductors involved shall provide sufficiently high current conducting capability and low impedance according to the relevant safety standards to avoid electric shock, risk of fire, or damage to the equipment under normal or faulty operating conditions within an equipment or the distribution network, or due to the impact of induced voltage and current, e.g. by lightning.